

MICRO SATA RECEPTACLE

1.0 SCOPE

This Product Specification covers the performance requirements of the Micro Serial ATA / High Speed Serialized device receptacle connector.

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND SERIES NUMBER(S)

Product Name

MICRO SATA RECEPTACLE, VERTICAL SMT

Series Number

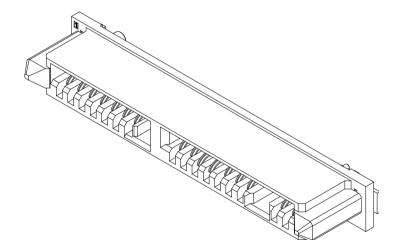
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2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See appropriate Sales Drawing for information on dimensions, materials, platings and markings.

2.3 SAFETY AGENCY APPROVALS

UL FILE	: E29179
CSA	: 1699020 (LR19980)



REVISION:	ECR/ECN INFORMATION:	TITLE: MICRO	SATA RECEPTAC	LE	SHEET No.
A1	<u>EC No:</u> S2015-0450		ERTICAL SMT		1 of 8
AI	DATE: 2015/04/15	1.8	INCH SSD/HDD		
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPRO	OVED BY:
PS	6-78492-001	SKANG	MLONG	ML	ONG
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3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

The following documents form a part of this specification to the extend specified herewith. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In addition, in event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

SATA Specification

4.0 RATINGS

4.1 VOLTAGE

30 Volts Max

4.2 CURRENT

1.5 Amps DC or AC (RMS) Max @ 60 Hz

4.3 TEMPERATURE

Operating: - 40°C to + 85°C Non Operating: - 40°C to + 85°C

4.4 HUMIDITY

20% - 80%

4.5 ATMOSPHERIC PRESSURE

650mm – 800mm Hg

5.0 PERFORMANCE

5.1 ELECTRICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
1	Low Level Contact Resistance (LLCR)	Subject mated contacts assembled in housing to 20 mV maximum open circuit at 100 mA maximum. (EIA 364-23)	30 mΩ MAXIMUM [Initial] 15 mΩ MAXIMUM [Delta change from Initial]
2	Insulation Resistance	Apply a voltage of 500 VDC for 1 minute between adjacent terminals. Measure the insulation resistance for mated and unmated connectors (EIA 364-21)	1000 MΩ MINIMUM

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	3	Contact Current Rating (Power Segment)	Mount connector to a test PCB with ½ oz copper layer. Wire two adjacent pins in parallel for supply (or the minimum number required by the connector type) Wire two adjacent pins in parallel for return (or the minimum number required by the connector type) Apply a DC current of two times the current rating per contact to the supply pins, returning through the return pins. Record temperature rise when thermal equilibrium is reached.	 1.5 A per pin MINIMUM Temperature rise shall not exceed 30°C at any point in the connector when contacts are powered Still Air at Ambient temperature 25°C
	4	Dielectric Withstanding Voltage	Apply a voltage of 500 VAC for 1 minute between adjacent terminals of mated and unmated connectors. (EIA 364-20 Method B)	No breakdown

5.2 MECHANICAL REQUIREMENTS

ITEM	DESCRIPTION TEST CONDITION		REQUIREMENT		
5	Connector Mate and Unmate Forces	Mate and Unmate connector assemblies at a rate of 12.5 mm per minute. (EIA 364-13)	Mate Force: 20 N MAXIMUM Unmate Force: 2.5 N MINIMUM [Initial and after Durability]		
6	Durability500 cycles for backplane / blindmate application. All at a maximum rate of 200 cycles per hour. (EIA 364-09)		No Physical damage		
7	Component Retention Force	Apply axial pull out force on terminal / solder tab in the housing at a rate of 25.4 mm per minute.	Terminal 3.00 N MINIMUM Solder Tab 3.50 N MINIMUM		

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PRODUCT SPECIFICATION

8	Physical Shock	Subject mated connector to 30 g's half-sine shock pulses of 11 msec duration. Three shocks in each direction applied along three mutually perpendicular planes for a total of 18 shocks. (EIA 364-27 Condition H) Test Set-Up in Section 8.0	No Physical damage No discontinuities of 1 μs or longer duration
9	Random Vibration	Subject mated connector to 5.35 g's RMS. 30 minutes in each of the three mutually perpendicular planes. (EIA 364-28 Condition V Test letter A) Test Set-Up in Section 8.0	No discontinuities of 1 μs or longer duration

5.3 ENVIRONMENTAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
ITEM DESCRIPTION 10 Humidity 11 Resistance to Soldering Heat		Subject the connector to temperature and humidity of 40 °C at 95 % RH for 96 hours. (EIA 364-31 Method II Test Condition A)	No Physical damage
10 Humidity		Refer to Section 9.0 for soldering profile	No damage in appearance of connector
12	Solderability	Unmated Connector. Steam age for 8 hours +/- 15 minutes. Solder Time: 3 \pm 0.5 seconds Solder Temperature: 260 \pm 5 °C Flux type: ROL0 (JESD 22-B-102 Condition C)	95 % MINIMUM Solder coverage
11Notestande to an appearanceSoldering HeatRefer to Section 9.0 for soldering profile12Soldering Heat12SolderabilitySolderabilityUnmated Connector. Steam age for 8 hours +/- 15 minutes. Solder Time: 3 ± 0.5 seconds Solder Temperature: 260 ± 5°C Flux type: ROL0 (JESD 22-B-102 Condition C)13Temperature LifeSubject mated connector to temperature life at +85°C for 500 hours. (EIA 364-17 Method A Test Condition 3)No Physical damageSubject connector to 10 cycles between	No Physical damage		
14	Thermal Shock	Subject connector to 10 cycles between - 55 °C and + 85 °C. (EIA 364-32 Test Condition I)	No Physical damage

6.0 PACKAGING

Parts shall be packaged to protect against damage during handling, transit and storage.

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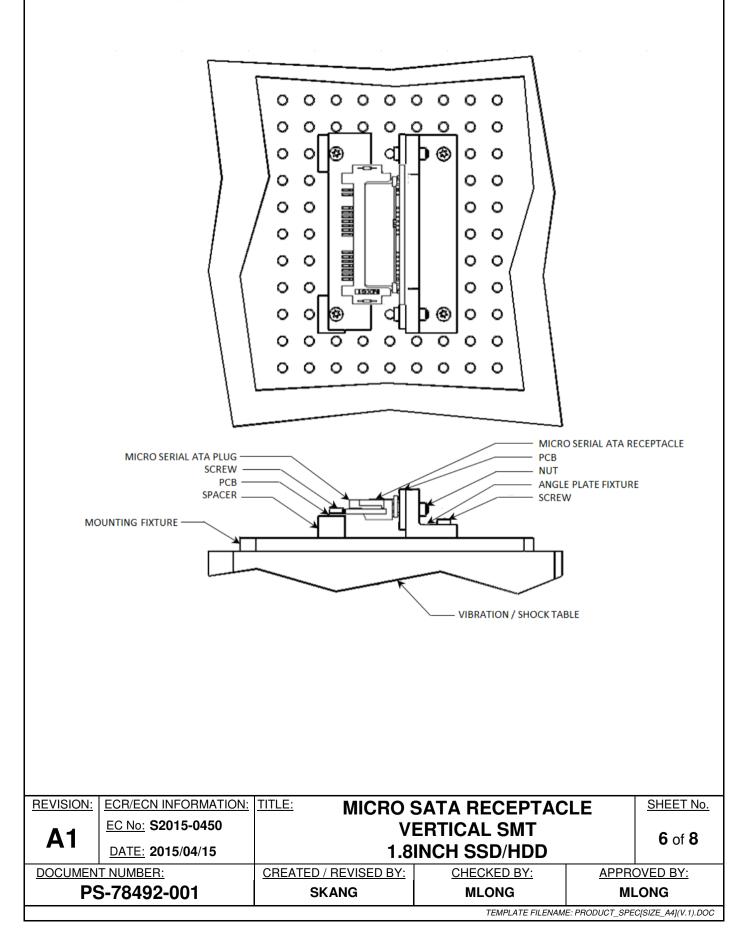
7.0 TEST SEQUENCES

Test Group >	Α	В	С	D	Е	F	G
Test or Examination $oldsymbol{\Psi}$							
Examination of the connector(s)	1, 5	1, 9	1, 8	1, 8	1	1, 5	
Low Level Contact Resistance (LLCR)	2, 4	3, 7	2, 4, 6				
Insulation Resistance				2, 6			
Dielectric Withstanding Voltage				3, 7			
Current Rating			7				
Mate Force		2				2	
Unmate Force		8				4	
Durability	3	4 ^(a)				3 ^(b)	
Physical Shock		6					
Vibration		5					
Humidity				5			
Temperature Life			3				
Reseating (manually unplug/plug three times)			5				
Thermal Shock				4			
Resistance to Soldering Heat					3		
Component Retention Force					2, 4		
Solderability							1
 (a) Preconditioning, 20 cycles durability cycles requireme cycles per hour. (b) Backplane Receptacle – 5 Mate/Unmate force of Cab well. The mate and unmate 	nt. The ma 00cycles, 0 le Power R	ate and i Cable Po Receptac	wer or Sig	ocle is at gnal Rec measure	the maxi eptacles d for 1 st t	mum rate - 50cycle o 5 th cycle	of 200
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8.0 VIBRATION/SHOCK TEST SET-UP (FOR REFERENCE ONLY)

Micro SATA plug with backplane receptacle





8.0 VIBRATION/SHOCK TEST SET-UP (FOR REFERENCE ONLY)

Micro SATA plug with cable receptacle

